MITSUBISHI IGBT MODULES

CM600DU-24NFH

HIGH POWER SWITCHING USE



APPLICATION

High frequency switching use (30kHz to 60kHz). Gradient amplifier, Induction heating, power supply, etc.





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Symbol	Parameter	Conditions	Ratings	Unit	
VCES	Collector-emitter voltage	G-E Short		1200	V
VGES	Gate-emitter voltage	C-E Short		±20	V
Ic	Collector current	Operation	(Note 2)	600	A
Ісм	Collector current	Pulse	(Note 2)	1200	A
IE (Note 1)		Operation	(Note 2)	600	A
IEM (Note 1)	Emitter current	Pulse	(Note 2)	1200	A
PC (Note 3)	Maximum collector dissipation	$TC = 25^{\circ}C$		1500	W
PC' (Note 3)	Maximum collector dissipation	$TC' = 25^{\circ}C^{*4}$		3670	W
Tj	Junction temperature			-40 ~ +150	°C
Tstg	Storage temperature			-40 ~ +125	°C
Viso	Isolation voltage	Terminals to base plate, $f = 60Hz$, AC 1 minute		2500	Vrms
_	NA	Main terminals M6 screw		3.5 ~ 4.5	N۰m
	Mounting torque	Mounting M6 screw	3.5 ~ 4.5	N•m	
_	Weight	Typical value		580	g

MAXIMUM RATINGS (Tj = 25°C, unless otherwise specified)

ELECTRICAL CHARACTERISTICS (Tj = 25°C, unless otherwise specified)

Oursels at	Davaaratan	Test conditions		Limits			
Symbol	Parameter			Min.	Тур.	Max.	Unit
ICES	Collector cutoff current	VCE = VCES, VGE = 0V		_	—	1	mA
VGE(th)	Gate-emitter threshold voltage	IC = 60mA, VCE = 10V		4.5	6	7.5	V
IGES	Gate leakage current	±VGE = VGES, VCE = 0V		_	_	2.0	μA
VCE(sat)	Collector-emitter saturation voltage	IC = 600A, VGE = 15V	Tj = 25°C Tj = 125°C	_	5.0 5.0	6.5	V
Cies	Input capacitance	VCE = 10V VGE = 0V		_		95	nF
Coes	Output capacitance			_	_	8.0	nF
Cres	Reverse transfer capacitance			_	_	1.8	nF
QG	Total gate charge	VCC = 600V, IC = 600A, VGE = 15V		_	2700	_	nC
td(on)	Turn-on delay time			_	—	400	ns
tr	Turn-on rise time	Vcc = 600V, Ic = 600A VGE = $\pm 15V$ RG = 0.52 Ω , Inductive load IE = 600A		_	_	120	ns
td(off)	Turn-off delay time			_	_	700	ns
tf	Turn-off fall time			_	_	150	ns
trr (Note 1)	Reverse recovery time			_	_	250	ns
Qrr (Note 1)	Reverse recovery charge			_	28	_	μC
VEC(Note 1)	Emitter-collector voltage	IE = 600A, VGE = 0V		_	_	3.5	V
Rth(j-c)Q	- Thermal resistance ^{*1}	IGBT part (1/2 module)		_	_	0.083	K/W
Rth(j-c)R		FWDi part (1/2 module)		_	_	0.15	K/W
Rth(c-f)	Contact thermal resistance	Case to heat sink, Thermal compound Applied ^{*2} (1/2 module)		_	0.02	_	K/W
Rth(j-c')Q	Thermal resistance*4	IGBT part (1/2 module)		_	—	0.034*3	K/W
Rth(j-c')R		FWDi part (1/2 module)		_	_	0.06 ^{*3}	K/W
Rg	External gate resistance			0.52	—	5.2	Ω

*1 : Case temperature (Tc) measured point is shown in page OUTLINE DRAWING.
*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].
*3 : If you use this value, Rth(f-a) should be measured just under the chips.
*4 : Case temperature (Tc') measured point is just under the chips.

Note 1. IE, VEC, trr & Qrr represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).

Pulse width and repetition rate should be such that the device junction temperature (Tj) does not exceed Tjmax rating.
 Junction temperature (Tj) should not increase beyond 150°C.
 No short circuit capability is designed.



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15

Tj = 25°C

IC = 1200A

IC = 600A

IC = 240A

18 20

Coes

20

OUTPUT CHARACTERISTICS TRANSFER CHARACTERISTICS (TYPICAL) (TYPICAL) 1200 1200 $T_i = 25^{\circ}C$ VGE=20 14 VCE = 10V13 (V) COLLECTOR CURRENT IC (A) COLLECTOR CURRENT Ic (A) 1000 1000 15 12 800 800 11 600 600 400 10 400 200 200 · 9 Ti = 25°C 8 -- Tj = 125°C 0⊾ 0 0⊾ 0 6 8 10 5 10 2 Λ COLLECTOR-EMITTER VOLTAGE VCE (V) GATE-EMITTER VOLTAGE VGE (V) **COLLECTOR-EMITTER SATURATION COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS VOLTAGE CHARACTERISTICS** (TYPICAL) (TYPICAL) g 10 VGE = 15VCOLLECTOR-EMITTER SATURATION VOLTAGE VCE(sat) (V) COLLECTOR-EMITTER SATURATION VOLTAGE VCE(sat) (V) 8 $T_j = 25^{\circ}C$ - Tj = 125°C 8 7 6 6 5 4 4 3 2 2 1 0⊾ 0 0⊾ 6 200 400 600 800 1000 1200 8 10 12 16 14 COLLECTOR CURRENT IC (A) GATE-EMITTER VOLTAGE VGE (V) FREE-WHEEL DIODE CAPACITANCE CHARACTERISTICS FORWARD CHARACTERISTICS (TYPICAL) (TYPICAL) 104 10<u>3</u> 7 5 6 Coes, Cres (nF) 32 3 EMITTER CURRENT IE (A) 2 10<u>2</u> 6 10³ 125 . Ti = 25°C 32 5 CAPACITANCE Cies, 10<u>1</u> 3 2 6 3 2 10² 10<u>0</u> 5 6 3 3 2 2 VGE = 0V10-1 2 3 5710⁰ 2 3 5710¹ 2 3 5710² 10¹ 2 З 4 0 1 5 EMITTER-COLLECTOR VOLTAGE VEC (V) COLLECTOR-EMITTER VOLTAGE VCE (V)

PERFORMANCE CURVES



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TRANSIENT THERMAL

IMPEDANCE CHARACTERISTICS



TIME (s)



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